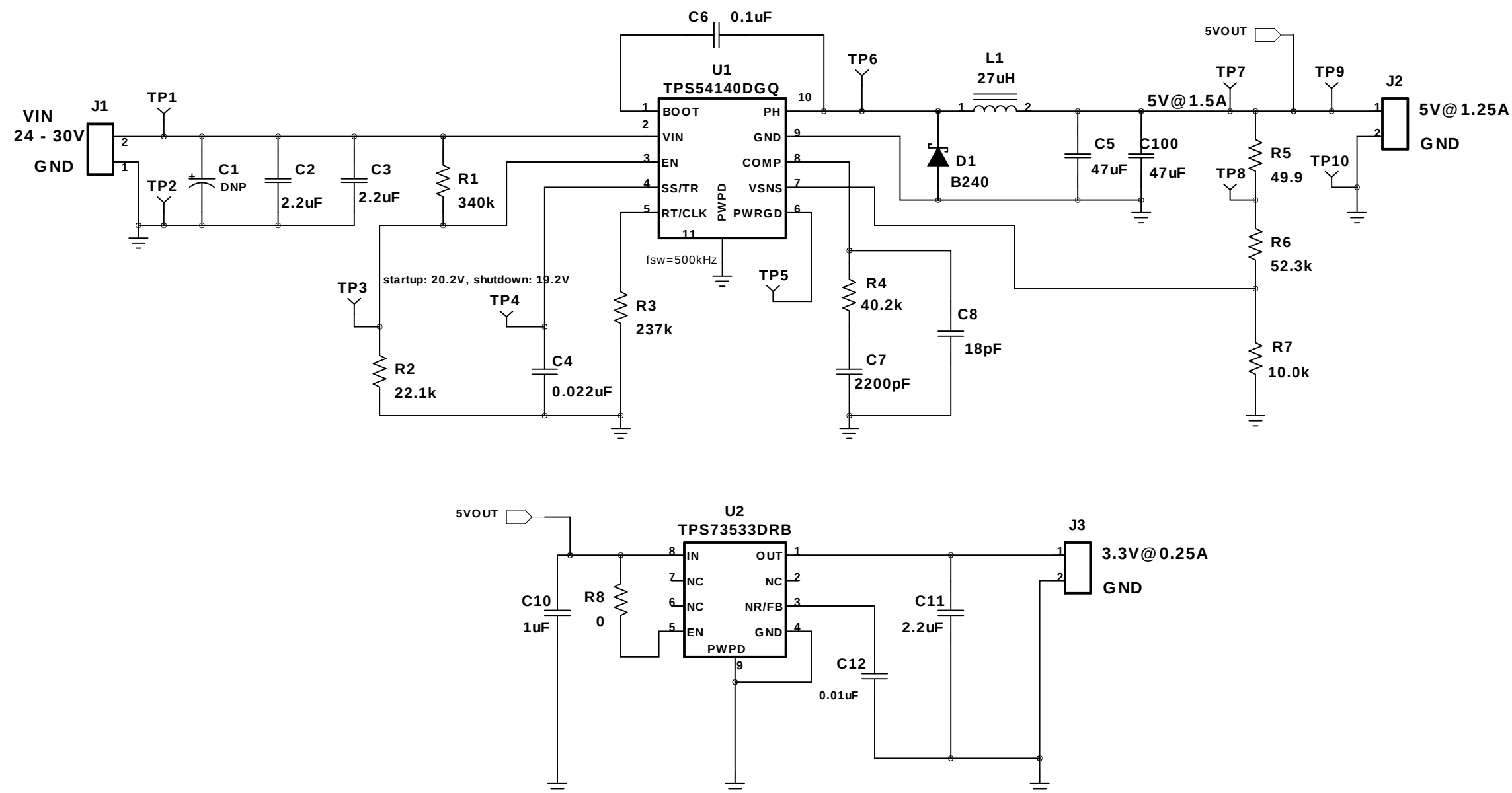




- NOTES:**
- 1) R5 for test purposes only
 - 2) DNP = "DO NOT POPULATE"
 - 3) REFdes > 99 were added on the board

Title			
Buck, LDO			
Size	Number	Rev	
B	PMP7076	B	
Date	1/16/12	Drawn by	E. Mueller
Filename	PMP7076_RevA.sch	Sheet	1 of 1

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